

OCT 11 2006

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Tews, *et al.* Docket No.: 2004 P 51343 US  
Serial No.: 10/840,146 Art Unit: 2814  
Filed: May 6, 2004 Examiner: Shrinivas H. Rao  
For: Semiconductor Structures and Manufacturing Methods

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT**

Dear Sir:

The following amendments and remarks are presented in response to the Examiner's Office Action mailed July 14, 2006. Please amend the above-referenced application as follows.

2004 P 51343 US

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Amendment



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Technology Center 2800	(including cover sheet)	
Facsimile Number: 571-273-5300	Transmission Date:	October 11, 2006

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Title:	Semiconductor Structures and Manufacturing Methods		

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Respectfully submitted,

*Theresa O'Connor*  
Theresa L. O'Connor  
Legal Assistant

Confirmation Respectfully Requested

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